IN THE CLAIMS

Please amend the claims as follows:

1. (Currently Amended) A multilayer wired board including at least part of an electrical circuit board in which a plurality of wired boards are stacked so as to face their wired surfaces toward each other, comprising:

electrical connection parts between said ~~multilayer~~ wired boards are connected through a first end of an elastic conductive material part adhered to ~~one of said wired boards~~ a first wired board, and a second end of the elastic conductive material part in contact with a second wired board;

a double-sided adhesive material part is provided between the plurality of wired boards to adhere them together, and an opening is formed in the double-sided adhesive material part so as to surround at least part of a peripheral edge portion of said elastic conductive material part to seal said plurality of ~~multilayer~~ wired boards;

wherein[[,]] a height of said double-sided adhesive material part is smaller than a height of said elastic conductive material part, and ~~is confined in diameter within the opening of said double-sided adhesive material part~~

the second end of the elastic conductive material part and a peripheral part of the second wired board are bent and pressed together.

2. (Original) The multilayer wired board according to claim 1, wherein said elastic conductive material part is formed in a convex shape, the bottom of said elastic conductive material part is adhered to one of said wired boards and the top of said elastic conductive material part is adhered to an electrical connection part of other side of said wired board, whereby electrical connection is established.

3. (Previously Presented) The multilayer wired board according to claim 1, wherein said elastic conductive material part is formed in a convex shape and the height from the bottom to the top of said elastic conductive material part is set to 200-400 μm.

4. (Withdrawn, Currently Amended) A method of a multilayer wired board constituting at least part of a electrical circuit board in which a plurality of wired boards are stacked so as to face their wired surfaces toward each other, comprising the steps of:

adhering a first end of an elastic conductive material part to an electric connection part of ~~one of said wired boards~~ a first wired board;

forming an opening in a double-sided adhesive material part so as to surround at least part of [[the]] a peripheral edge of said elastic conductive material part;

adhering said double-sided adhesive material part to [[a]] the first wired board adhered to said elastic conductive material part or ~~other~~ a second wired board whose wired surface is to be faced to ~~said~~ a wired surface of the first wired board; and

adhering said ~~both~~ first and second wired boards together by said double-sided adhesive material part under the state in which ~~the top~~ a second end of said elastic conductive material part is ~~contacted to~~ in contact with the electrical connection part of said ~~other~~ second wired board ~~whose wired surface to be faced to said wired surface,~~

wherein a height of said double-sided adhesive material part is smaller than a height of said elastic conductive material part, and

the second end of the elastic conductive material part and a peripheral part of the second wired board are bent and pressed together.

5. (Withdrawn) The method of a multilayer wired board according to claim 4, wherein said elastic conductive material part is formed in a convex shape.

6. (Withdrawn) The method of a multilayer wired board according to claim 4, wherein said elastic conductive material part is formed in a convex shape and the height from the bottom to the top of said elastic conductive board is set to 200-400 μm.

7. (Currently Amended) A touch panel, comprising:

a light transmission first board having a light transmission conductive layer formed as a predetermined pattern thereon and a light transmission second board made of a flexible material having a light transmission conductive layer thereon and opposing said first board by a predetermined distance;

electrical connection parts between said first board and said second board being connected through a first end of an elastic conductive material part adhered only to said first board, and a second end of the elastic conductive material part in contact with the second board;

a double-sided adhesive material part provided between the ~~plurality of wired boards~~ the first board and the second board to adhere them together, and an opening being formed in the double-sided adhesive material part so as to surround at least part of a peripheral edge portion of said elastic conductive material part to seal said first board and said second board;

wherein[[,]] a height of said double-sided adhesive material part is smaller than a height of said elastic conductive material part, and ~~is confined in diameter within the opening of said double-sided adhesive material part~~

the second end of the elastic conductive material part and a peripheral part of the second board are bent and pressed together.

8. (Original) The touch panel according to claim 7, wherein said elastic conductive material part is formed in a convex shape, the bottom of said elastic conductive material part is adhered to said first board and the top of said elastic conductive material part is adhered to an electrical connection part of said second board, whereby electrical connection is established.

9. (Previously Presented) The touch panel according to claim 7, wherein said elastic conductive material part is formed in a convex shape and the height from the bottom to the top of said elastic conductive material part is set to 200-400 μm.

10. (Withdrawn, Currently Amended) A method of a touch panel ~~comprising the~~ including a configuration such that a light transmission first board having a light transmission conductive layer formed as a predetermined pattern thereon and a light transmission second board made of a flexible material having a light transmission conductive layer thereon is placed opposite to said first board with a predetermined distance, comprising the steps of:

adhering a first end of an elastic conductive material part to an electric connection part of said first board;

forming an opening in a double-sided adhesive material part so as to surround at least part of [[the]] a peripheral edge of said elastic conductive material part;

adhering said double-sided adhesive material part to said first board and said second board; and

adhering said ~~both fist~~ first board and said second board together by said double-sided adhesive material part under the state in which ~~the top~~ a second end of said elastic conductive material part is ~~contacted to~~ in contact with the electrical connection part of said second board,

wherein a height of said double-sided adhesive material part is smaller than a height of said elastic conductive material part, and

the second end of the elastic conductive material part and a peripheral part of the second board are bent and pressed together.

11. (Withdrawn) The method of a touch panel according to claim 10, wherein said elastic conductive material part is formed in a convex shape.

12. (Withdrawn) The method of a touch panel according to claim 10, wherein said elastic conductive material part is formed in a convex shape and the height from the bottom to the top of said elastic conductive board is set to 200-400 μm.

13. (Previously Presented) The multilayer board according to claim 1, wherein said elastic conductive material part does not contact said double-sided adhesive material part.

14. (Previously Presented) The touch panel according to claim 7, wherein said elastic conductive material part does not contact said double-sided adhesive material part.